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STMicroelectronics STPS3L60SY

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Automotive power Schottky rectifier

Features

- Negligible switching losses
- Low thermal resistance
- Avalanche capability specified
- AEC Q101 qualified
- ECOPACK[®]2 compliant component

Description

Schottky rectifier suited for switched mode power supplies and high frequency DC to DC converters.

Packaged in SMC this device is intended for use in DC/DC chargers for automotive applications.

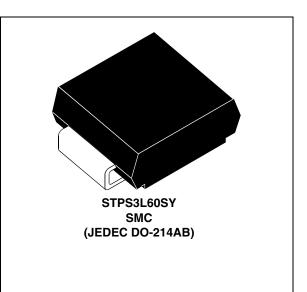


Table 1.Device summary

I _{F(AV)}	3 A	
V _{RRM}	60 V	
T _{j (max)}	150 °C	
V _{F (max)}	0.65 V	



Characteristics

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1 Characteristics

Table 2. Absolute ratings (limiting values)

Symbol	Paramet	Value	Unit	
V _{RRM}	Repetitive peak reverse voltage	60	V	
I _{F(RMS)}	Forward rms current		10	А
I _{F(AV)}	Average forward current	$T_C = 100 \ ^{\circ}C \ \delta = 0.5$	3	А
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms Sinusoidal	75	А
I _{RRM}	Repetitive peak reverse current $t_p = 2 \ \mu s$ square F=1 kHz		1	А
P _{ARM}	Repetitive peak avalanche power $t_p = 1 \ \mu s \ T_j = 25 \ ^{\circ}C$		1600	W
T _{stg}	Storage temperature range	-65 to +175	°C	
Тj	Operating junction temperature range ⁽¹⁾		-40 to +150	°C
dV/dt	Critical rate of rise reverse voltage	10000	V/µs	

1. $\frac{dPtot}{dTj} < \frac{1}{Rth(j-a)}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistances

Symbol	Parameter	Value	Unit
R _{th (j-l)}	R _{th (j-l)} Junction to leads		° C/W

Table 4. Static electrical characteristics

Symbol	Parameter	Tests co	Min.	Тур.	Max.	Unit	
I _R ⁽¹⁾ Rever	Reverse leakage current	T _j = 25 °C	V _R = V _{RRM}			55	μA
	neverse leakage current	T _j = 125 °C			10	15	mA
V _F ⁽¹⁾	Forward voltage drop	T _j = 25 °C	I _F = 3 A			0.7	
		T _j = 125 °C	I _F = 3 A		0.56	0.65	V
		T _j = 25 °C	I _F = 6 A			0.94	v
		T _j = 125 °C	I _F = 6 A		0.67	0.76	

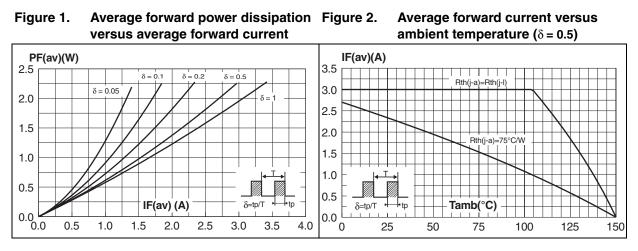
1. Pulse test: t_p = 380 µs, δ < 2%

To evaluate the conduction losses use the following equation: P = 0.54 x $I_{F(AV)}$ + 0.037x ${I_F}^2_{(RMS)}$





Characteristics



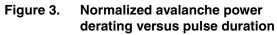


Figure 4. Normalized avalanche power derating versus junction temperature

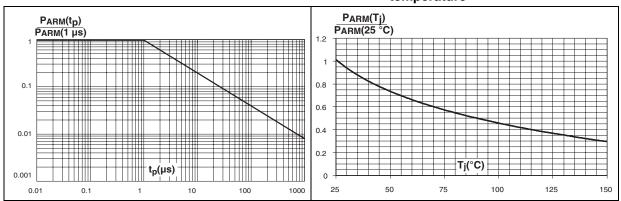
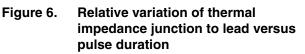
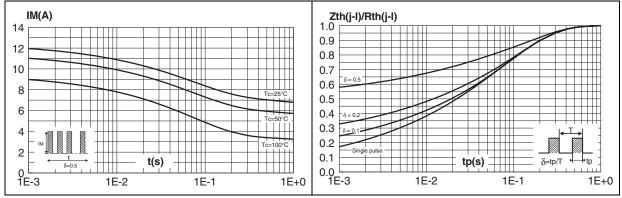


Figure 5. Non repetitive surge peak forward current versus overload duration (maximum values)







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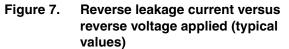
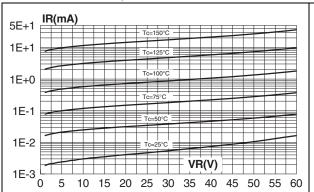


Figure 8. Junction capacitance versus reverse voltage applied (typical values)



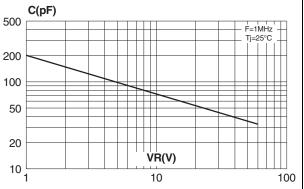
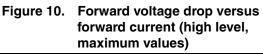
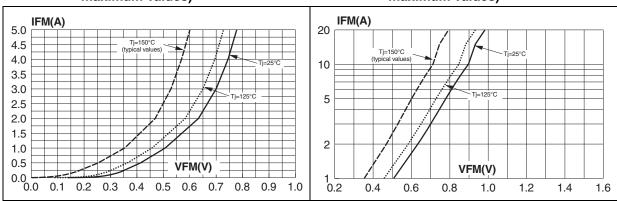
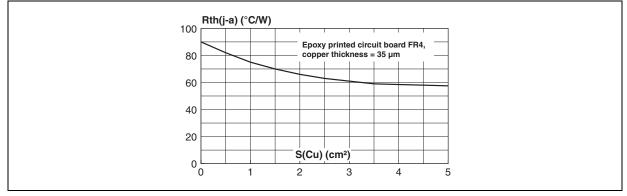


Figure 9. Forward voltage drop versus forward current (low level, maximum values)













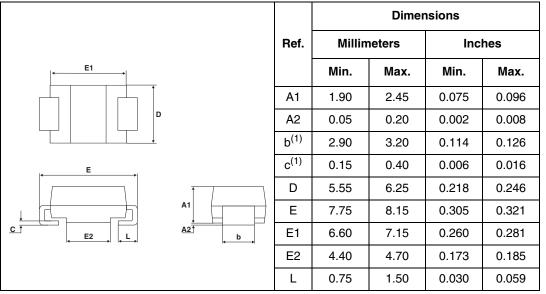
Package information

2 Package information

- Epoxy meets UL94,V0
- Lead-free package

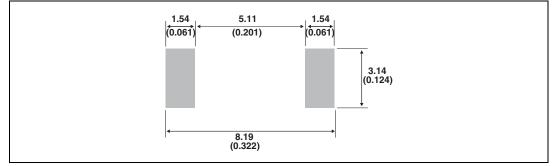
In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Table 5. SMC Dimensions



1. Dimensions b and c apply to plated leads

Figure 12. Footprint, dimensions in mm (inches)







Ordering information

STPS3L60-Y

3 Ordering information

Table 6.Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STPS3L60SY	S36Y	SMC	0.24 g	2500	Tape and reel

4 **Revision history**

Table 7.Document revision history

Date	Revision	Changes
15-Sep-2011	1	Initial release.



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